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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded - Microcontrollers</u>"

Details	
Product Status	Active
Core Processor	AVR
Core Size	8-Bit
Speed	8MHz
Connectivity	EBI/EMI, I ² C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	86
Program Memory Size	256KB (128K x 16)
Program Memory Type	FLASH
EEPROM Size	4K x 8
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 5.5V
Data Converters	A/D 16x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	100-TQFP
Supplier Device Package	100-TQFP (14x14)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/atmega2560v-8au

Figure 1-2. CBGA-pinout ATmega640/1280/2560

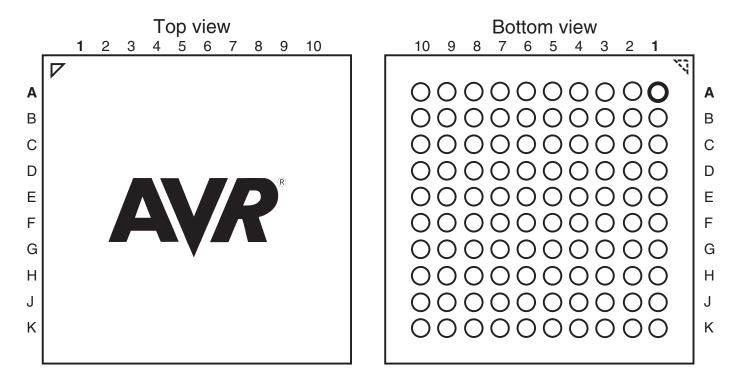


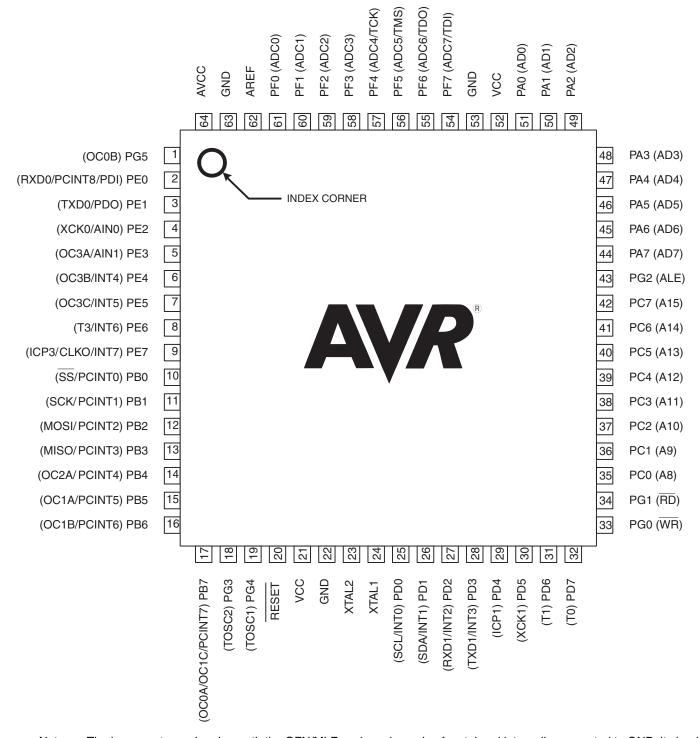
Table 1-1. CBGA-pinout ATmega640/1280/2560

	1	2	3	4	5	6	7	8	9	10
	'	2	3	4	3	0	1	0	9	10
Α	GND	AREF	PF0	PF2	PF5	PK0	PK3	PK6	GND	VCC
В	AVCC	PG5	PF1	PF3	PF6	PK1	PK4	PK7	PA0	PA2
С	PE2	PE0	PE1	PF4	PF7	PK2	PK5	PJ7	PA1	PA3
D	PE3	PE4	PE5	PE6	PH2	PA4	PA5	PA6	PA7	PG2
E	PE7	PH0	PH1	PH3	PH5	PJ6	PJ5	PJ4	PJ3	PJ2
F	VCC	PH4	PH6	PB0	PL4	PD1	PJ1	PJ0	PC7	GND
G	GND	PB1	PB2	PB5	PL2	PD0	PD5	PC5	PC6	VCC
Н	PB3	PB4	RESET	PL1	PL3	PL7	PD4	PC4	PC3	PC2
J	PH7	PG3	PB6	PL0	XTAL2	PL6	PD3	PC1	PC0	PG1
K	PB7	PG4	VCC	GND	XTAL1	PL5	PD2	PD6	PD7	PG0

Note: The functions for each pin is the same as for the 100 pin packages shown in Figure 1-1 on page 2.



Figure 1-3. Pinout ATmega1281/2561



Note: The large center pad underneath the QFN/MLF package is made of metal and internally connected to GND. It should be soldered or glued to the board to ensure good mechanical stability. If the center pad is left unconnected, the package might loosen from the board.

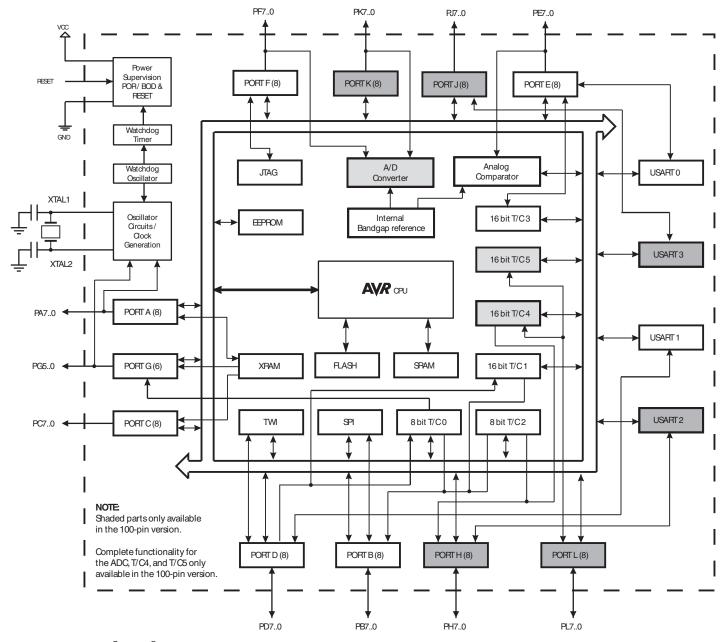


2. Overview

The ATmega640/1280/1281/2560/2561 is a low-power CMOS 8-bit microcontroller based on the AVR enhanced RISC architecture. By executing powerful instructions in a single clock cycle, the ATmega640/1280/1281/2560/2561 achieves throughputs approaching 1 MIPS per MHz allowing the system designer to optimize power consumption versus processing speed.

2.1 Block Diagram

Figure 2-1. Block Diagram



The Atmel® AVR® core combines a rich instruction set with 32 general purpose working registers. All the 32 registers are directly connected to the Arithmetic Logic Unit (ALU), allowing two independent registers to be accessed in one single instruction executed in one clock cycle. The resulting architecture is more code efficient while achieving throughputs up to ten times faster than conventional CISC microcontrollers.



2.2 Comparison Between ATmega1281/2561 and ATmega640/1280/2560

Each device in the ATmega640/1280/1281/2560/2561 family differs only in memory size and number of pins. Table 2-1 summarizes the different configurations for the six devices.

Table 2-1. Configuration Summary

Device	Flash	EEPROM	RAM	General Purpose I/O pins	16 bits resolution PWM channels	Serial USARTs	ADC Channels
ATmega640	64KB	4KB	8KB	86	12	4	16
ATmega1280	128KB	4KB	8KB	86	12	4	16
ATmega1281	128KB	4KB	8KB	54	6	2	8
ATmega2560	256KB	4KB	8KB	86	12	4	16
ATmega2561	256KB	4KB	8KB	54	6	2	8

2.3 Pin Descriptions

2.3.1 VCC

Digital supply voltage.

2.3.2 GND

Ground.

2.3.3 Port A (PA7..PA0)

Port A is an 8-bit bi-directional I/O port with internal pull-up resistors (selected for each bit). The Port A output buffers have symmetrical drive characteristics with both high sink and source capability. As inputs, Port A pins that are externally pulled low will source current if the pull-up resistors are activated. The Port A pins are tri-stated when a reset condition becomes active, even if the clock is not running.

Port A also serves the functions of various special features of the ATmega640/1280/1281/2560/2561 as listed on page 75.

2.3.4 Port B (PB7..PB0)

Port B is an 8-bit bi-directional I/O port with internal pull-up resistors (selected for each bit). The Port B output buffers have symmetrical drive characteristics with both high sink and source capability. As inputs, Port B pins that are externally pulled low will source current if the pull-up resistors are activated. The Port B pins are tri-stated when a reset condition becomes active, even if the clock is not running.

Port B has better driving capabilities than the other ports.

Port B also serves the functions of various special features of the ATmega640/1280/1281/2560/2561 as listed on page 76.

2.3.5 Port C (PC7..PC0)

Port C is an 8-bit bi-directional I/O port with internal pull-up resistors (selected for each bit). The Port C output buffers have symmetrical drive characteristics with both high sink and source capability. As inputs, Port C pins that are externally pulled low will source current if the pull-up resistors are activated. The Port C pins are tri-stated when a reset condition becomes active, even if the clock is not running.

Port C also serves the functions of special features of the ATmega640/1280/1281/2560/2561 as listed on page 79.



2.3.6 Port D (PD7..PD0)

Port D is an 8-bit bi-directional I/O port with internal pull-up resistors (selected for each bit). The Port D output buffers have symmetrical drive characteristics with both high sink and source capability. As inputs, Port D pins that are externally pulled low will source current if the pull-up resistors are activated. The Port D pins are tri-stated when a reset condition becomes active, even if the clock is not running.

Port D also serves the functions of various special features of the ATmega640/1280/1281/2560/2561 as listed on page 80.

2.3.7 Port E (PE7..PE0)

Port E is an 8-bit bi-directional I/O port with internal pull-up resistors (selected for each bit). The Port E output buffers have symmetrical drive characteristics with both high sink and source capability. As inputs, Port E pins that are externally pulled low will source current if the pull-up resistors are activated. The Port E pins are tri-stated when a reset condition becomes active, even if the clock is not running.

Port E also serves the functions of various special features of the ATmega640/1280/1281/2560/2561 as listed on page 82.

2.3.8 Port F (PF7..PF0)

Port F serves as analog inputs to the A/D Converter.

Port F also serves as an 8-bit bi-directional I/O port, if the A/D Converter is not used. Port pins can provide internal pull-up resistors (selected for each bit). The Port F output buffers have symmetrical drive characteristics with both high sink and source capability. As inputs, Port F pins that are externally pulled low will source current if the pull-up resistors are activated. The Port F pins are tri-stated when a reset condition becomes active, even if the clock is not running. If the JTAG interface is enabled, the pull-up resistors on pins PF7(TDI), PF5(TMS), and PF4(TCK) will be activated even if a reset occurs.

Port F also serves the functions of the JTAG interface.

2.3.9 Port G (PG5..PG0)

Port G is a 6-bit I/O port with internal pull-up resistors (selected for each bit). The Port G output buffers have symmetrical drive characteristics with both high sink and source capability. As inputs, Port G pins that are externally pulled low will source current if the pull-up resistors are activated. The Port G pins are tri-stated when a reset condition becomes active, even if the clock is not running.

Port G also serves the functions of various special features of the ATmega640/1280/1281/2560/2561 as listed on page 86.

2.3.10 Port H (PH7..PH0)

Port H is a 8-bit bi-directional I/O port with internal pull-up resistors (selected for each bit). The Port H output buffers have symmetrical drive characteristics with both high sink and source capability. As inputs, Port H pins that are externally pulled low will source current if the pull-up resistors are activated. The Port H pins are tri-stated when a reset condition becomes active, even if the clock is not running.

Port H also serves the functions of various special features of the ATmega640/1280/2560 as listed on page 88.

2.3.11 Port J (PJ7..PJ0)

Port J is a 8-bit bi-directional I/O port with internal pull-up resistors (selected for each bit). The Port J output buffers have symmetrical drive characteristics with both high sink and source capability. As inputs, Port J pins that are externally pulled low will source current if the pull-up resistors are activated. The Port J pins are tri-stated when a reset condition becomes active, even if the clock is not running. Port J also serves the functions of various special features of the ATmega640/1280/2560 as listed on page 90.



7. Register Summary

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Page
(0x1FF)	Reserved	-	-	-	-	-	-	-	-	
	Reserved	-	-	-	-	-	-	-	-	
(0x13F)	Reserved									
(0x13E)	Reserved									
(0x13D)	Reserved									
(0x13C)	Reserved									
(0x13B)	Reserved									
(0x13A)	Reserved									
(0x139)	Reserved									
(0x138)	Reserved									
(0x137)	Reserved UDR3				LICADTO I/O	Data Danistan				nama 010
(0x136) (0x135)	UBRR3H	-	-	-	USANTS I/C	Data Register	ICADT2 Paud Pa	te Register High E	Duto	page 218
(0x135) (0x134)	UBRR3L	-	-			ate Register Low I		te Register High E	byte	page 222 page 222
(0x134)	Reserved	-	-	-	- L		-	-	-	page 222
(0x132)	UCSR3C	UMSEL31	UMSEL30	UPM31	UPM30	USBS3	UCSZ31	UCSZ30	UCPOL3	page 235
(0x131)	UCSR3B	RXCIE3	TXCIE3	UDRIE3	RXEN3	TXEN3	UCSZ32	RXB83	TXB83	page 234
(0x130)	UCSR3A	RXC3	TXC3	UDRE3	FE3	DOR3	UPE3	U2X3	MPCM3	page 233
(0x12F)	Reserved	-	-	-	-	-	-	-	-	P 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2
(0x12E)	Reserved	-	-	-	-	-	-	-	-	
(0x12D)	OCR5CH			Timer/Co	unter5 - Output C	ompare Register	C High Byte			page 160
(0x12C)	OCR5CL					Compare Register				page 160
(0x12B)	OCR5BH			Timer/Co	unter5 - Output C	ompare Register	B High Byte			page 160
(0x12A)	OCR5BL					Compare Register				page 160
(0x129)	OCR5AH			Timer/Co	unter5 - Output C	ompare Register	A High Byte			page 160
(0x128)	OCR5AL			Timer/Co	unter5 - Output C	ompare Register	A Low Byte			page 160
(0x127)	ICR5H			Timer/0	Counter5 - Input (Capture Register	High Byte			page 161
(0x126)	ICR5L			Timer/	Counter5 - Input	Capture Register	Low Byte			page 161
(0x125)	TCNT5H			Time	er/Counter5 - Co	unter Register Hig	gh Byte			page 158
(0x124)	TCNT5L			Tim	er/Counter5 - Co	unter Register Lo	w Byte			page 158
(0x123)	Reserved	-	-	-	-	-	-	-	-	
(0x122)	TCCR5C	FOC5A	FOC5B	FOC5C	-	-	-	-	-	page 157
(0x121)	TCCR5B	ICNC5	ICES5	-	WGM53	WGM52	CS52	CS51	CS50	page 156
(0x120)	TCCR5A	COM5A1	COM5A0	COM5B1	COM5B0	COM5C1	COM5C0	WGM51	WGM50	page 154
(0x11F)	Reserved	-	-	-	-	-	-	-	-	
(0x11E)	Reserved	-	-	-	-	-	-	-	-	
(0x11D)	Reserved Reserved	-	-	-	-	-	-	-	-	
(0x11C) (0x11B)	Reserved	-	-	-	-	-	-	-	-	
(0x11B) (0x11A)	Reserved	-	-		-	-	-	_	-	
(0x11A)	Reserved	-	-	-	-	-	-	-	-	
(0x118)	Reserved	-	-	-	-	-	-	-	-	
(0x117)	Reserved	-	_	-	-	_	_	-	-	
(0x116)	Reserved	-	-	-	-	-	-	-	-	
(0x115)	Reserved	-	-	-	-	-	-	-	-	
(0x114)	Reserved	-	-	-	-	-	-	-	-	
(0x113)	Reserved	-	-	-	-	-	-	-	-	
(0x112)	Reserved	-	-	-	-	-	-	-	-	
(0x111)	Reserved	-	-	-	-	-	-	-	-	
(0x110)	Reserved	-	-	-	-	-	-	-	-	
(0x10F)	Reserved	-	-	-	-	-	-	-	-	
(0x10E)	Reserved	-	-	-	-	-	-	-	-	
(0x10D)	Reserved	-	-	-	-	-	-	-	-	
(0x10C)	Reserved	-	-	-	-	-	-	-	- DODTI O	
(0x10B)	PORTL	PORTL7	PORTL6	PORTL5	PORTL4	PORTL3	PORTL2	PORTL1	PORTL0	page 100
(0x10A)	DDRL PINL	DDL7 PINL7	DDL6 PINL6	DDL5	DDL4	DDL3	DDL2	DDL1	DDL0	page 100
(0x109)	PORTK	PINL7 PORTK7	PORTK6	PINL5 PORTK5	PINL4 PORTK4	PINL3 PORTK3	PINL2 PORTK2	PINL1 PORTK1	PINL0 PORTK0	page 100
(0x108)	DDRK	DDK7	DDK6	DDK5	DDK4	DDK3	DDK2	DDK1	DDK0	page 99 page 99
(0v107)		אטט			PINK4	PINK3	PINK2	PINK1	PINK0	page 99
(0x107) (0x106)		PINK7	PINKE			I HALLO	1 1131134	1 11313.1	I II VI VU	page 00
(0x106)	PINK	PINK7 PORT.I7	PINK6 PORTJ6	PINK5 PORTJ5			PURT 12	PORT I1	PORT.In	page 90
(0x106) (0x105)	PINK PORTJ	PORTJ7	PORTJ6	PORTJ5	PORTJ4	PORTJ3	PORTJ2 DDJ2	PORTJ1	PORTJ0	page 99
(0x106) (0x105) (0x104)	PINK PORTJ DDRJ	PORTJ7 DDJ7	PORTJ6 DDJ6	PORTJ5 DDJ5	PORTJ4 DDJ4	PORTJ3 DDJ3	DDJ2	DDJ1	DDJ0	page 99
(0x106) (0x105)	PINK PORTJ	PORTJ7	PORTJ6	PORTJ5	PORTJ4	PORTJ3				



(0xBC) (0xBB) (0xBA) (0xB9) (0xB8) (0xB7)	TWCR TWDR TWAR	TWINT	TWEA	TWSTA						
(0xBA) (0xB9) (0xB8)				IWSIA	TWSTO	TWWC	TWEN	-	TWIE	page 261
(0xB9) (0xB8)	TWAR		Ī		2-wire Serial Inte			T	1	page 263
(0xB8)	THIOD	TWA6	TWA5	TWA4	TWA3	TWA2	TWA1	TWA0	TWGCE	page 263
` '	TWSR TWBR	TWS7	TWS6	TWS5	TWS4 -wire Serial Interfa	TWS3	-	TWPS1	TWPS0	page 262
(OXBI)	Reserved	_	_		-wire Senai inten	L L	_	-	_	page 261
(0xB6)	ASSR	-	EXCLK	AS2	TCN2UB	OCR2AUB	OCR2BUB	TCR2AUB	TCR2BUB	page 179
(0xB5)	Reserved	-	-	-	-	-	-	-	-	p a g
(0xB4)	OCR2B			Tim	ner/Counter2 Outp	out Compare Reg	ister B	•	•	page 186
(0xB3)	OCR2A			Tin	ner/Counter2 Outp		ister A			page 186
(0xB2)	TCNT2				Timer/Co	unter2 (8 Bit)			T	page 186
(0xB1)	TCCR2B TCCR2A	FOC2A COM2A1	FOC2B COM2A0	- COMOD4	- COMORO	WGM22	CS22	CS21	CS20	page 185
(0xB0) (0xAF)	Reserved	- CONIZAT	- COMZAU	COM2B1	COM2B0			WGM21	WGM20	page 186
(0xAE)	Reserved	-	-	-	-	-	-	-	-	
(0xAD)	OCR4CH			Timer/Co	unter4 - Output C	ompare Register	C High Byte			page 160
(0xAC)	OCR4CL			Timer/Co	unter4 - Output C	ompare Register	C Low Byte			page 160
(0xAB)	OCR4BH				unter4 - Output C					page 160
(0xAA)	OCR4BL				unter4 - Output C					page 160
(0xA9)	OCR4AH				unter4 - Output C					page 159
(0xA8) (0xA7)	OCR4AL ICR4H				unter4 - Output C Counter4 - Input (page 159 page 161
(0xA7) (0xA6)	ICR4L				Counter4 - Input (1 0	,			page 161
(0xA5)	TCNT4H				er/Counter4 - Cou	•	•			page 158
(0xA4)	TCNT4L				er/Counter4 - Cou		•			page 158
(0xA3)	Reserved	-	-	-	-	-	-	-	-	
(0xA2)	TCCR4C	FOC4A	FOC4B	FOC4C	-	-	-	-	-	page 157
(0xA1)	TCCR4B	ICNC4	ICES4	-	WGM43	WGM42	CS42	CS41	CS40	page 156
(0xA0)	TCCR4A	COM4A1	COM4A0	COM4B1	COM4B0	COM4C1	COM4C0	WGM41	WGM40	page 154
(0x9F)	Reserved	-	-	-	-	-	-	-	-	
(0x9E) (0x9D)	Reserved OCR3CH	-	-					-	-	page 159
(0x9C)	OCR3CL		Timer/Counter3 - Output Compare Register C High Byte Timer/Counter3 - Output Compare Register C Low Byte							page 159
(0x9B)	OCR3BH				unter3 - Output C					page 159
(0x9A)	OCR3BL			Timer/Co	unter3 - Output C	ompare Register	B Low Byte			page 159
(0x99)	OCR3AH				unter3 - Output C					page 159
(0x98)	OCR3AL				unter3 - Output C					page 159
(0x97)	ICR3H ICR3L				Counter3 - Input (Counter3 - Input (<u> </u>	• •			page 161
(0x96) (0x95)	TCNT3H				er/Counter3 - Cou					page 161 page 158
(0x94)	TCNT3L				er/Counter3 - Cou		•			page 158
(0x93)	Reserved	-	-	-	-	-	-	-	-	, ,
(0x92)	TCCR3C	FOC3A	FOC3B	FOC3C	-	-	-	-	-	page 157
(0x91)	TCCR3B	ICNC3	ICES3	-	WGM33	WGM32	CS32	CS31	CS30	page 156
(0x90)	TCCR3A	COM3A1	COM3A0	COM3B1	COM3B0	COM3C1	COM3C0	WGM31	WGM30	page 154
(0x8F)	Reserved	-	-	-	-	-	-	-	-	
(0x8E) (0x8D)	Reserved OCR1CH	-	-	Timer/Co	unter1 - Output C	omnare Register	C High Byte	-	-	page 159
(0x8C)	OCR1CL				unter1 - Output C					page 159
(0x8B)	OCR1BH				unter1 - Output C		•			page 159
(0x8A)	OCR1BL			Timer/Co	unter1 - Output C	ompare Register	B Low Byte			page 159
(0x89)	OCR1AH				unter1 - Output C					page 159
(0x88)	OCR1AL				unter1 - Output C					page 159
(0x87)	ICR1H				Counter1 - Input (page 160
(0x86) (0x85)	ICR1L TCNT1H				Counter1 - Input (er/Counter1 - Cou	<u> </u>				page 160 page 158
(0x84)	TCNT1h TCNT1L				er/Counter1 - Cou					page 158
(0x83)	Reserved	-	-	-	-	-	-	-	-	h=31 130
(0x82)	TCCR1C	FOC1A	FOC1B	FOC1C	-	-	-	-	-	page 157
(0x81)	TCCR1B	ICNC1	ICES1	•	WGM13	WGM12	CS12	CS11	CS10	page 156
(0x80)	TCCR1A	COM1A1	COM1A0	COM1B1	COM1B0	COM1C1	COM1C0	WGM11	WGM10	page 154
(0x7F)	DIDR1	- AD07D	-	-	-	- AD00D	- AD00D	AIN1D	AIN0D	page 267
(0x7E)	DIDR0 DIDR2	ADC7D	ADC6D	ADC5D	ADC12D	ADC3D	ADC2D	ADC1D	ADC0D	page 287
(0x7D) (0x7C)	ADMUX	ADC15D REFS1	ADC14D REFS0	ADC13D ADLAR	ADC12D MUX4	ADC11D MUX3	ADC10D MUX2	ADC9D MUX1	ADC8D MUX0	page 288 page 281
(0x7C) (0x7B)	ADCSRB	-	ACME	- ADLAN	-	MUX5	ADTS2	ADTS1	ADTS0	page 266, 282, 287
(0x7A)	ADCSRA	ADEN	ADSC	ADATE	ADIF	ADIE	ADPS2	ADPS1	ADPS0	page 285
(0x79)	ADCH					gister High byte			•	page 286



Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Page
(0x78)	ADCL				ADC Data Re	egister Low byte		•		page 286
(0x77)	Reserved	-	-	-	-	-	-	-	-	
(0x76)	Reserved	-	-	-	-	-	-	-	-	
(0x75)	XMCRB	XMBK	-	-	-	-	XMM2	XMM1	XMM0	page 38
(0x74) (0x73)	XMCRA TIMSK5	SRE -	SRL2	SRL1 ICIE5	SRL0	SRW11 OCIE5C	SRW10 OCIE5B	SRW01 OCIE5A	SRW00 TOIE5	page 36
(0x73) (0x72)	TIMSK4	-	-	ICIE5	-	OCIE4C	OCIE3B OCIE4B	OCIE4A	TOIE3	page 162 page 161
(0x71)	TIMSK3	-	-	ICIE3	-	OCIE3C	OCIE3B	OCIE3A	TOIE3	page 161
(0x70)	TIMSK2	-	-	-	-	-	OCIE2B	OCIE2A	TOIE2	page 188
(0x6F)	TIMSK1	-	-	ICIE1	-	OCIE1C	OCIE1B	OCIE1A	TOIE1	page 161
(0x6E)	TIMSK0	-	-	-	-	-	OCIE0B	OCIE0A	TOIE0	page 131
(0x6D)	PCMSK2	PCINT23	PCINT22	PCINT21	PCINT20	PCINT19	PCINT18	PCINT17	PCINT16	page 113
(0x6C)	PCMSK1	PCINT15	PCINT14	PCINT13	PCINT12	PCINT11	PCINT10	PCINT9	PCINT8	page 113
(0x6B)	PCMSK0	PCINT7	PCINT6	PCINT5	PCINT4	PCINT3	PCINT2	PCINT1	PCINT0	page 114
(0x6A) (0x69)	EICRB EICRA	ISC71 ISC31	ISC70 ISC30	ISC61 ISC21	ISC60 ISC20	ISC51 ISC11	ISC50 ISC10	ISC41 ISC01	ISC40 ISC00	page 110
(0x69) (0x68)	PCICR	-	-	-	15020	-	PCIE2	PCIE1	PCIE0	page 110 page 112
(0x67)	Reserved	-	-	-	-	-	-	-	-	page 112
(0x66)	OSCCAL				Oscillator Cal	bration Register				page 48
(0x65)	PRR1	-	-	PRTIM5	PRTIM4	PRTIM3	PRUSART3	PRUSART2	PRUSART1	page 56
(0x64)	PRR0	PRTWI	PRTIM2	PRTIM0	-	PRTIM1	PRSPI	PRUSART0	PRADC	page 55
(0x63)	Reserved	-	-	-	-	-	-	-	-	
(0x62)	Reserved	-	-	-	-	-	-	-	-	
(0x61)	CLKPR	CLKPCE	-	-	-	CLKPS3	CLKPS2	CLKPS1	CLKPS0	page 48
(0x60)	WDTCSR	WDIF	WDIE	WDP3	WDCE	WDE V	WDP2	WDP1	WDP0	page 65
0x3F (0x5F) 0x3E (0x5E)	SREG SPH	SP15	T SP14	H SP13	S SP12	SP11	N SP10	Z SP9	C SP8	page 13 page 15
0x3D (0x5D)	SPL	SP7	SP6	SP5	SP4	SP3	SP2	SP1	SP0	page 15
0x3C (0x5C)	EIND	-	-	-	-	-	-	-	EIND0	page 16
0x3B (0x5B)	RAMPZ	-	-	-	-	-	-	RAMPZ1	RAMPZ0	page 16
0x3A (0x5A)	Reserved	-	-	-	-	-	-	-	-	
0x39 (0x59)	Reserved	-	-	-	-	-	-	-	-	
0x38 (0x58)	Reserved	-	-	-	-	-	-	-	-	
0x37 (0x57)	SPMCSR	SPMIE	RWWSB	SIGRD	RWWSRE	BLBSET	PGWRT	PGERS	SPMEN	page 323
0x36 (0x56)	Reserved	- ITD	-	-	- DUD	-	-	- IVCEI	-	neme C4 100 00 001
0x35 (0x55) 0x34 (0x54)	MCUCR MCUSR	JTD -	-	-	PUD JTRF	WDRF	BORF	IVSEL EXTRF	IVCE PORF	page 64, 108, 96, 301 page 301
0x33 (0x53)	SMCR	-	-	-	-	SM2	SM1	SM0	SE	page 50
0x32 (0x52)	Reserved	-	-	-	-	-	-	-	-	page
0x31 (0x51)	OCDR	OCDR7	OCDR6	OCDR5	OCDR4	OCDR3	OCDR2	OCDR1	OCDR0	page 294
0x30 (0x50)	ACSR	ACD	ACBG	ACO	ACI	ACIE	ACIC	ACIS1	ACIS0	page 266
0x2F (0x4F)	Reserved	-	-	-	-	-	-	-	-	
0x2E (0x4E)	SPDR				SPI Da	ta Register	1	ı		page 199
0x2D (0x4D)	SPSR	SPIF	WCOL	-	-	-	-	-	SPI2X	page 198
0x2C (0x4C)	SPCR	SPIE	SPE	DORD	MSTR Conoral Burns	CPOL	CPHA	SPR1	SPR0	page 197
0x2B (0x4B) 0x2A (0x4A)	GPIOR2 GPIOR1					se I/O Register 2 se I/O Register 1				page 36 page 36
0x29 (0x49)	Reserved	-	-	-	-	-	-	-	-	page oo
0x28 (0x48)	OCR0B			Tin	ner/Counter0 Out	out Compare Reg	ister B			page 130
0x27 (0x47)	OCR0A				ner/Counter0 Out					page 130
0x26 (0x46)	TCNT0				Timer/Co	unter0 (8 Bit)				page 130
0x25 (0x45)	TCCR0B	FOC0A	FOC0B	-	-	WGM02	CS02	CS01	CS00	page 129
0x24 (0x44)	TCCR0A	COM0A1	COM0A0	COM0B1	COM0B0	-	-	WGM01	WGM00	page 126
0x23 (0x43)	GTCCR	TSM	-	-	-	-	-	PSRASY	PSRSYNC	page 166, 189
0x22 (0x42) 0x21 (0x41)	EEARH EEARL	-	-	-	- EEDDOM Add		EEPROM Address	s Hegister High B	уте	page 34 page 34
0x21 (0x41) 0x20 (0x40)	EEDR		EEPROM Address Register Low Byte EEPROM Data Register						page 34	
0x1F (0x3F)	EECR	-	-	EEPM1	EEPM0	EERIE	EEMPE	EEPE	EERE	page 34
0x1E (0x3E)	GPIOR0					se I/O Register 0				page 36
0x1D (0x3D)	EIMSK	INT7	INT6	INT5	INT4	INT3	INT2	INT1	INT0	page 111
0x1C (0x3C)	EIFR	INTF7	INTF6	INTF5	INTF4	INTF3	INTF2	INTF1	INTF0	page 112
0x1B (0x3B)	PCIFR	-	-	-	-		PCIF2	PCIF1	PCIF0	page 113
0x1A (0x3A)	TIFR5	-	-	ICF5	-	OCF5C	OCF5B	OCF5A	TOV5	page 162
0x19 (0x39)	TIFR4	-	-	ICF4	-	OCF4C	OCF4B	OCF4A	TOV4	page 162
0x18 (0x38)	TIFR3	-	-	ICF3	-	OCF3C	OCF3B	OCF3A	TOV3	page 162
0x17 (0x37) 0x16 (0x36)	TIFR2 TIFR1	-	-	- ICF1	-	OCF1C	OCF2B OCF1B	OCF2A OCF1A	TOV2 TOV1	page 188
0x15 (0x35)	TIFRI TIFR0	-	-	-	-	-	OCF1B OCF0B	OCF1A OCF0A	TOV1	page 162 page 131
0.10 (0.00)	III NO	_	•	-	_	-	1 00100	COLON	1000	page 101



Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Page
0x14 (0x34)	PORTG	-	-	PORTG5	PORTG4	PORTG3	PORTG2	PORTG1	PORTG0	page 98
0x13 (0x33)	DDRG	-	-	DDG5	DDG4	DDG3	DDG2	DDG1	DDG0	page 98
0x12 (0x32)	PING	-	-	PING5	PING4	PING3	PING2	PING1	PING0	page 98
0x11 (0x31)	PORTF	PORTF7	PORTF6	PORTF5	PORTF4	PORTF3	PORTF2	PORTF1	PORTF0	page 97
0x10 (0x30)	DDRF	DDF7	DDF6	DDF5	DDF4	DDF3	DDF2	DDF1	DDF0	page 98
0x0F (0x2F)	PINF	PINF7	PINF6	PINF5	PINF4	PINF3	PINF2	PINF1	PINF0	page 98
0x0E (0x2E)	PORTE	PORTE7	PORTE6	PORTE5	PORTE4	PORTE3	PORTE2	PORTE1	PORTE0	page 97
0x0D (0x2D)	DDRE	DDE7	DDE6	DDE5	DDE4	DDE3	DDE2	DDE1	DDE0	page 97
0x0C (0x2C)	PINE	PINE7	PINE6	PINE5	PINE4	PINE3	PINE2	PINE1	PINE0	page 98
0x0B (0x2B)	PORTD	PORTD7	PORTD6	PORTD5	PORTD4	PORTD3	PORTD2	PORTD1	PORTD0	page 97
0x0A (0x2A)	DDRD	DDD7	DDD6	DDD5	DDD4	DDD3	DDD2	DDD1	DDD0	page 97
0x09 (0x29)	PIND	PIND7	PIND6	PIND5	PIND4	PIND3	PIND2	PIND1	PIND0	page 97
0x08 (0x28)	PORTC	PORTC7	PORTC6	PORTC5	PORTC4	PORTC3	PORTC2	PORTC1	PORTC0	page 97
0x07 (0x27)	DDRC	DDC7	DDC6	DDC5	DDC4	DDC3	DDC2	DDC1	DDC0	page 97
0x06 (0x26)	PINC	PINC7	PINC6	PINC5	PINC4	PINC3	PINC2	PINC1	PINC0	page 97
0x05 (0x25)	PORTB	PORTB7	PORTB6	PORTB5	PORTB4	PORTB3	PORTB2	PORTB1	PORTB0	page 96
0x04 (0x24)	DDRB	DDB7	DDB6	DDB5	DDB4	DDB3	DDB2	DDB1	DDB0	page 96
0x03 (0x23)	PINB	PINB7	PINB6	PINB5	PINB4	PINB3	PINB2	PINB1	PINB0	page 96
0x02 (0x22)	PORTA	PORTA7	PORTA6	PORTA5	PORTA4	PORTA3	PORTA2	PORTA1	PORTA0	page 96
0x01 (0x21)	DDRA	DDA7	DDA6	DDA5	DDA4	DDA3	DDA2	DDA1	DDA0	page 96
0x00 (0x20)	PINA	PINA7	PINA6	PINA5	PINA4	PINA3	PINA2	PINA1	PINA0	page 96

- Notes: 1. For compatibility with future devices, reserved bits should be written to zero if accessed. Reserved I/O memory addresses should never be written.
 - 2. I/O registers within the address range \$00 \$1F are directly bit-accessible using the SBI and CBI instructions. In these registers, the value of single bits can be checked by using the SBIS and SBIC instructions.
 - 3. Some of the status flags are cleared by writing a logical one to them. Note that the CBI and SBI instructions will operate on all bits in the I/O register, writing a one back into any flag read as set, thus clearing the flag. The CBI and SBI instructions work with registers 0x00 to 0x1F only.
 - 4. When using the I/O specific commands IN and OUT, the I/O addresses \$00 \$3F must be used. When addressing I/O registers as data space using LD and ST instructions, \$20 must be added to these addresses. The ATmega640/1280/1281/2560/2561 is a complex microcontroller with more peripheral units than can be supported within the 64 location reserved in Opcode for the IN and OUT instructions. For the Extended I/O space from \$60 - \$1FF in SRAM, only the ST/STS/STD and LD/LDS/LDD instructions can be used.



Mnemonics	Operands	Description	Operation	Flags	#Clocks
BRVC	k	Branch if Overflow Flag is Cleared	if (V = 0) then PC ← PC + k + 1	None	1/2
BRIE	k	Branch if Interrupt Enabled	if (I = 1) then $PC \leftarrow PC + k + 1$	None	1/2
BRID	k	Branch if Interrupt Disabled	if (I = 0) then PC ← PC + k + 1	None	1/2
BIT AND BIT-TEST	INSTRUCTIONS				
SBI	P,b	Set Bit in I/O Register	I/O(P,b) ← 1	None	2
CBI	P,b	Clear Bit in I/O Register	I/O(P,b) ← 0	None	2
LSL	Rd	Logical Shift Left	$Rd(n+1) \leftarrow Rd(n), Rd(0) \leftarrow 0$	Z, C, N, V	1
LSR	Rd	Logical Shift Right	$Rd(n) \leftarrow Rd(n+1), Rd(7) \leftarrow 0$	Z, C, N, V	1
ROL	Rd	Rotate Left Through Carry	$Rd(0)\leftarrow C,Rd(n+1)\leftarrow Rd(n),C\leftarrow Rd(7)$	Z, C, N, V	1
ROR	Rd	Rotate Right Through Carry	$Rd(7)\leftarrow C,Rd(n)\leftarrow Rd(n+1),C\leftarrow Rd(0)$	Z, C, N, V	1
ASR	Rd	Arithmetic Shift Right	Rd(n) ← Rd(n+1), n=06	Z, C, N, V	1
SWAP	Rd	Swap Nibbles	Rd(30)←Rd(74),Rd(74)←Rd(30)	None	1
BSET	s	Flag Set	SREG(s) ← 1	SREG(s)	1
BCLR	S	Flag Clear	SREG(s) ← 0	SREG(s)	1
BST	Rr, b	Bit Store from Register to T	T ← Rr(b)	T	1
BLD SEC	Rd, b	Bit load from T to Register	Rd(b) ← T	None C	1
CLC		Set Carry	C ← 1 C ← 0	C	1
SEN		Clear Carry Set Negative Flag	N ← 1	N	1
CLN		Clear Negative Flag	N ← 1 N ← 0	N	1
SEZ		Set Zero Flag	Z ← 1	Z	1
CLZ		Clear Zero Flag	Z←1 Z←0	Z	1
SEI		Global Interrupt Enable	1←1	1	1
CLI		Global Interrupt Disable	1←0	1 i	1
SES		Set Signed Test Flag	S ← 1	S	1
CLS		Clear Signed Test Flag	S ← 0	S	1
SEV		Set Twos Complement Overflow.	V ← 1	V	1
CLV		Clear Twos Complement Overflow	V ← 0	V	1
SET		Set T in SREG	T ← 1	T	1
CLT		Clear T in SREG	T ← 0	Т	1
SEH		Set Half Carry Flag in SREG	H ← 1	Н	1
CLH		Clear Half Carry Flag in SREG	H ← 0	Н	1
DATA TRANSFER I	NSTRUCTIONS			•	
MOV	Rd, Rr	Move Between Registers	Rd ← Rr	None	1
MOVW	Rd, Rr	Copy Register Word	Rd+1:Rd ← Rr+1:Rr	None	1
LDI	Rd, K	Load Immediate	Rd ← K	None	1
LD	Rd, X	Load Indirect	$Rd \leftarrow (X)$	None	2
LD	Rd, X+	Load Indirect and Post-Inc.	$Rd \leftarrow (X), X \leftarrow X + 1$	None	2
LD	Rd, - X	Load Indirect and Pre-Dec.	$X \leftarrow X - 1$, $Rd \leftarrow (X)$	None	2
LD	Rd, Y	Load Indirect	$Rd \leftarrow (Y)$	None	2
LD	Rd, Y+	Load Indirect and Post-Inc.	$Rd \leftarrow (Y), Y \leftarrow Y + 1$	None	2
LD	Rd, - Y	Load Indirect and Pre-Dec.	$Y \leftarrow Y - 1$, $Rd \leftarrow (Y)$	None	2
LDD	Rd,Y+q	Load Indirect with Displacement	$Rd \leftarrow (Y + q)$	None	2
LD	Rd, Z	Load Indirect	Rd ← (Z)	None	2
LD	Rd, Z+	Load Indirect and Pro Pro	$Rd \leftarrow (Z), Z \leftarrow Z+1$	None	2
LDD	Rd, -Z Rd, Z+q	Load Indirect and Pre-Dec. Load Indirect with Displacement	$Z \leftarrow Z - 1$, $Rd \leftarrow (Z)$	None	2
LDS	Rd, Z+q Rd, k	Load Direct from SRAM	$Rd \leftarrow (Z + q)$ $Rd \leftarrow (k)$	None None	2
ST	X, Rr	Store Indirect	$(X) \leftarrow Rr$	None	2
ST	X+, Rr	Store Indirect and Post-Inc.	$(X) \leftarrow \Pi$ $(X) \leftarrow Rr, X \leftarrow X + 1$	None	2
ST	- X, Rr	Store Indirect and Pre-Dec.	$X \leftarrow X - 1, (X) \leftarrow Rr$	None	2
ST	Y, Rr	Store Indirect	$(Y) \leftarrow Rr$	None	2
ST	Y+, Rr	Store Indirect and Post-Inc.	$(Y) \leftarrow Rr, Y \leftarrow Y + 1$	None	2
ST	- Y, Rr	Store Indirect and Pre-Dec.	$Y \leftarrow Y - 1, (Y) \leftarrow Rr$	None	2
STD	Y+q,Rr	Store Indirect with Displacement	$(Y + q) \leftarrow Rr$	None	2
ST	Z, Rr	Store Indirect	(Z) ← Rr	None	2
ST	Z+, Rr	Store Indirect and Post-Inc.	$(Z) \leftarrow \operatorname{Rr}, Z \leftarrow Z + 1$	None	2
ST	-Z, Rr	Store Indirect and Pre-Dec.	$Z \leftarrow Z - 1$, $(Z) \leftarrow Rr$	None	2
STD	Z+q,Rr	Store Indirect with Displacement	(Z + q) ← Rr	None	2
STS	k, Rr	Store Direct to SRAM	(k) ← Rr	None	2
LPM		Load Program Memory	R0 ← (Z)	None	3
LPM	Rd, Z	Load Program Memory	$Rd \leftarrow (Z)$	None	3
LPM	Rd, Z+	Load Program Memory and Post-Inc	$Rd \leftarrow (Z), Z \leftarrow Z+1$	None	3
ELPM		Extended Load Program Memory	$R0 \leftarrow (RAMPZ:Z)$	None	3
ELPM	Rd, Z	Extended Load Program Memory	$Rd \leftarrow (RAMPZ:Z)$	None	3
ELPIVI	, _				1
ELPM	Rd, Z+	Extended Load Program Memory	$Rd \leftarrow (RAMPZ:Z), RAMPZ:Z \leftarrow RAMPZ:Z+1$	None	3
		Extended Load Program Memory Store Program Memory	$Rd \leftarrow (RAMPZ:Z), RAMPZ:Z \leftarrow RAMPZ:Z+1$ $(Z) \leftarrow R1:R0$	None None	3 -



Ordering Information 9.

9.1 ATmega640

Speed [MHz] ⁽²⁾	Power Supply	Ordering Code	Package ⁽¹⁾⁽³⁾	Operation Range	
8	1.8 - 5.5V ATmega640V-8AU ATmega640V-8CU ATmega640V-8CUR ⁽⁴⁾		100A 100A 100C1 100C1	Industrial (-40°C to 85°C)	
16	2.7 - 5.5V	ATmega640-16AU ATmega640-16AUR ⁽⁴⁾ ATmega640-16CU ATmega640-16CUR ⁽⁴⁾	100A 100A 100C1 100C1	industrial (*40 0 to 65 0)	

- Notes: 1. This device can also be supplied in wafer form. Contact your local Atmel sales office for detailed ordering information and minimum quantities.
 - 2. See "Speed Grades" on page 357.
 - 3. Pb-free packaging, complies to the European Directive for Restriction of Hazardous Substances (RoHS directive). Also Halide free and fully Green.
 - 4. Tape & Reel.

	Package Type						
100A	100-lead, Thin (1.0mm) Plastic Gull Wing Quad Flat Package (TQFP)						
100C1	100-ball, Chip Ball Grid Array (CBGA)						



9.2 ATmega1280

Speed [MHz] ⁽²⁾	Power Supply	Ordering Code	Package ⁽¹⁾⁽³⁾	Operation Range
8	1.8V - 5.5V	ATmega1280V-8AU ATmega1280V-8AUR ⁽⁴⁾ ATmega1280V-8CU ATmega1280V-8CUR ⁽⁴⁾	100A 100A 100C1 100C1	Industrial (-40°C to 85°C)
16	2.7V - 5.5V	ATmega1280-16AU ATmega1280-16AUR ⁽⁴⁾ ATmega1280-16CU ATmega1280-16CUR ⁽⁴⁾	100A 100A 100C1 100C1	industrial (-40 C to 65 C)

Notes: 1. This device can also be supplied in wafer form. Contact your local Atmel sales office for detailed ordering information and minimum quantities.

- 2. See "Speed Grades" on page 357.
- 3. Pb-free packaging, complies to the European Directive for Restriction of Hazardous Substances (RoHS directive). Also Halide free and fully Green.
- 4. Tape & Reel.

Package Type						
100A	100-lead, Thin (1.0mm) Plastic Gull Wing Quad Flat Package (TQFP)					
100C1	100-ball, Chip Ball Grid Array (CBGA)					



ATmega1281 9.3

Speed [MHz] ⁽²⁾	Power Supply	Ordering Code	Package ⁽¹⁾⁽³⁾	Operation Range	
8	1.8 - 5.5V	ATmega1281V-8AU ATmega1281V-8AUR ⁽⁴⁾ ATmega1281V-8MU ATmega1281V-8MUR ⁽⁴⁾	64A 64A 64M2 64M2	Industrial	
16	2.7 - 5.5V	ATmega1281-16AU ATmega1281-16AUR ⁽⁴⁾ ATmega1281-16MU ATmega1281-16MUR ⁽⁴⁾	64A 64A 64M2 64M2	(-40°C to 85°C)	

- Notes: 1. This device can also be supplied in wafer form. Contact your local Atmel sales office for detailed ordering information and minimum quantities.
 - 2. See "Speed Grades" on page 357.
 - 3. Pb-free packaging, complies to the European Directive for Restriction of Hazardous Substances (RoHS directive). Also Halide free and fully Green.
 - 4. Tape & Reel.

Package Type		
64A	64-lead, Thin (1.0mm) Plastic Gull Wing Quad Flat Package (TQFP)	
64M2	64-pad, 9mm × 9mm × 1.0mm Body, Quad Flat No-lead/Micro Lead Frame Package (QFN/MLF)	



9.4 ATmega2560

Speed [MHz] ⁽²⁾	Power Supply	Ordering Code	Package ⁽¹⁾⁽³⁾	Operation Range
8	1.8V - 5.5V	ATmega2560V-8AU ATmega2560V-8AUR ⁽⁴⁾ ATmega2560V-8CU ATmega2560V-8CUR ⁽⁴⁾	100A 100A 100C1 100C1	Industrial (-40°C to 85°C)
16	4.5V - 5.5V	ATmega2560-16AU ATmega2560-16AUR ⁽⁴⁾ ATmega2560-16CU ATmega2560-16CUR ⁽⁴⁾	100A 100A 100C1 100C1	

Notes: 1. This device can also be supplied in wafer form. Contact your local Atmel sales office for detailed ordering information and minimum quantities.

- 2. See "Speed Grades" on page 357.
- 3. Pb-free packaging, complies to the European Directive for Restriction of Hazardous Substances (RoHS directive). Also Halide free and fully Green.
- 4. Tape & Reel.

Package Type		
100A	100-lead, Thin (1.0mm) Plastic Gull Wing Quad Flat Package (TQFP)	
100C1	100-ball, Chip Ball Grid Array (CBGA)	



9.5 ATmega2561

Speed [MHz] ⁽²⁾	Power Supply	Ordering Code	Package ⁽¹⁾⁽³⁾	Operation Range
8	1.8V - 5.5V	ATmega2561V-8AU ATmega2561V-8AUR ⁽⁴⁾ ATmega2561V-8MU ATmega2561V-8MUR ⁽⁴⁾	64A 64A 64M2 64M2	Industrial (-40°C to 85°C)
16	4.5V - 5.5V	ATmega2561-16AU ATmega2561-16AUR ⁽⁴⁾ ATmega2561-16MU ATmega2561-16MUR ⁽⁴⁾	64A 64A 64M2 64M2	

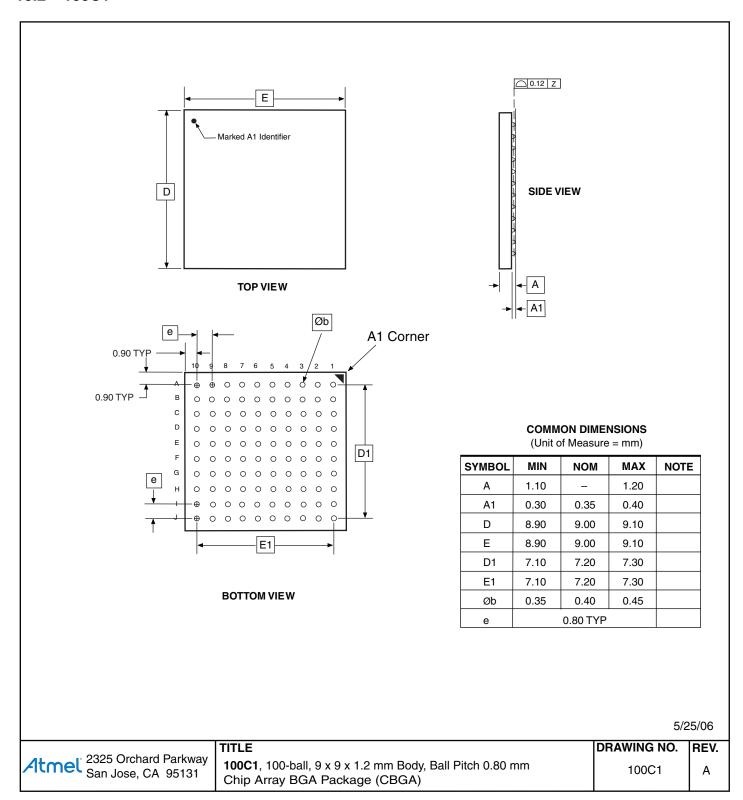
Notes: 1. This device can also be supplied in wafer form. Contact your local Atmel sales office for detailed ordering information and minimum quantities.

- 2. See "Speed Grades" on page 357.
- 3. Pb-free packaging, complies to the European Directive for Restriction of Hazardous Substances (RoHS directive). Also Halide free and fully Green.
- 4. Tape & Reel.

Package Type		
64 A	64-lead, Thin (1.0mm) Plastic Gull Wing Quad Flat Package (TQFP)	
64M2	64-pad, 9mm × 9mm × 1.0mm Body, Quad Flat No-lead/Micro Lead Frame Package (QFN/MLF)	

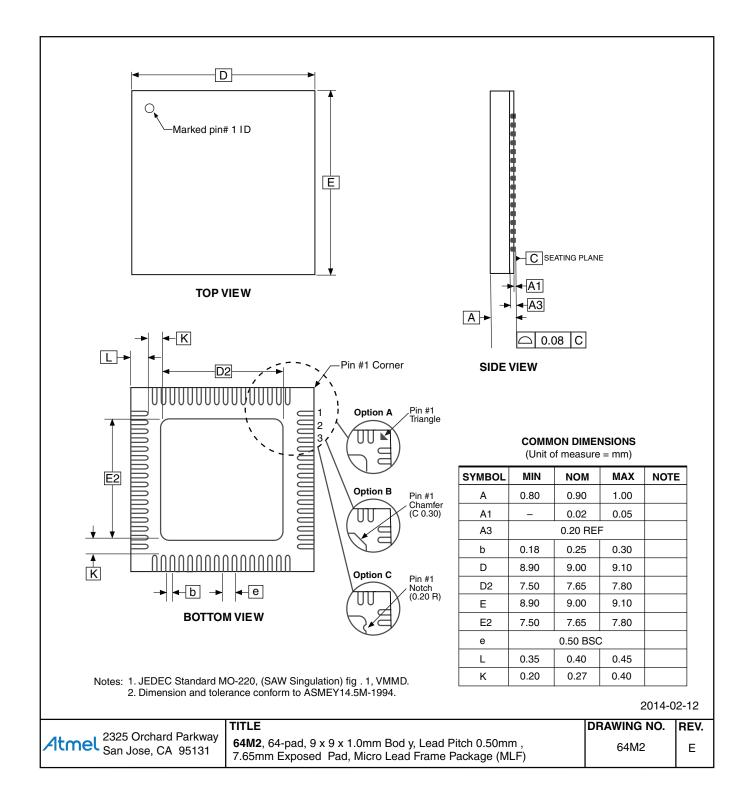


10.2 100C1





10.4 64M2





5. IN/OUT instructions may be executed twice when Stack is in external RAM

If either an IN or an OUT instruction is executed directly before an interrupt occurs and the stack pointer is located in external ram, the instruction will be executed twice. In some cases this will cause a problem, for example:

- If reading SREG it will appear that the I-flag is cleared.
- If writing to the PIN registers, the port will toggle twice.
- If reading registers with interrupt flags, the flags will appear to be cleared.

Problem Fix/Workaround

There are two application workarounds, where selecting one of them, will be omitting the issue:

- Replace IN and OUT with LD/LDS/LDD and ST/STS/STD instructions.
- Use internal RAM for stack pointer.

6. EEPROM read from application code does not work in Lock Bit Mode 3

When the Memory Lock Bits LB2 and LB1 are programmed to mode 3, EEPROM read does not work from the application code.

Problem Fix/Workaround

Do not set Lock Bit Protection Mode 3 when the application code needs to read from EEPROM.

11.13 ATmega2561 rev. F

- ADC differential input amplification by 46dB (200x) not functional
- ADC differential input amplification by 46dB (200x) not functional Problem Fix/Workaround

None.

11.14 ATmega2561 rev. E

No known errata.

11.15 ATmega2561 rev. D

Not sampled.

11.16 ATmega2561 rev. C

· High current consumption in sleep mode.

1. High current consumption in sleep mode

If a pending interrupt cannot wake the part up from the selected sleep mode, the current consumption will increase during sleep when executing the SLEEP instruction directly after a SEI instruction.

Problem Fix/Workaround

Before entering sleep, interrupts not used to wake the part from the sleep mode should be disabled.

11.17 ATmega2561 rev. B

Not sampled.



11.18 ATmega2561 rev. A

- Non-Read-While-Write area of flash not functional
- · Part does not work under 2.4 Volts
- Incorrect ADC reading in differential mode
- Internal ADC reference has too low value
- IN/OUT instructions may be executed twice when Stack is in external RAM
- EEPROM read from application code does not work in Lock Bit Mode 3

1. Non-Read-While-Write area of flash not functional

The Non-Read-While-Write area of the flash is not working as expected. The problem is related to the speed of the part when reading the flash of this area.

Problem Fix/Workaround

- Only use the first 248K of the flash.
- If boot functionality is needed, run the code in the Non-Read-While-Write area at maximum 1/4th of the maximum frequency of the device at any given voltage. This is done by writing the CLKPR register before entering the boot section of the code.

2. Part does not work under 2.4 volts

The part does not execute code correctly below 2.4 volts.

Problem Fix/Workaround

Do not use the part at voltages below 2.4 volts.

3. Incorrect ADC reading in differential mode

The ADC has high noise in differential mode. It can give up to 7 LSB error.

Problem Fix/Workaround

Use only the 7 MSB of the result when using the ADC in differential mode.

4. Internal ADC reference has too low value

The internal ADC reference has a value lower than specified.

Problem Fix/Workaround

- Use AVCC or external reference.
- The actual value of the reference can be measured by applying a known voltage to the ADC when using the internal reference. The result when doing later conversions can then be calibrated.

5. IN/OUT instructions may be executed twice when Stack is in external RAM

If either an IN or an OUT instruction is executed directly before an interrupt occurs and the stack pointer is located in external ram, the instruction will be executed twice. In some cases this will cause a problem, for example:

- If reading SREG it will appear that the I-flag is cleared.
- If writing to the PIN registers, the port will toggle twice.
- If reading registers with interrupt flags, the flags will appear to be cleared.

Problem Fix/Workaround

There are two application workarounds, where selecting one of them, will be omitting the issue:

- Replace IN and OUT with LD/LDS/LDD and ST/STS/STD instructions.















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